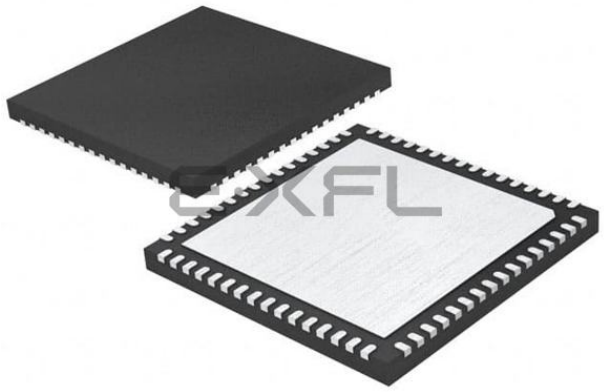

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	53
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-VQFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f67k22t-i-mr

TABLE 1-3: PIC18F6XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	QFN/TQFP			
				PORTE is a bidirectional I/O port.
RE0/$\overline{RD}$/P2D	2			
RE0		I/O	ST	Digital I/O.
$\overline{RD}$		I	TTL	Parallel Slave Port read strobe.
P2D		O	—	EECP2 PWM Output D.
RE1/$\overline{WR}$/P2C	1			
RE1		I/O	ST	Digital I/O.
$\overline{WR}$		I	TTL	Parallel Slave Port write strobe.
P2C		O	—	ECCP2 PWM Output C.
RE2/$\overline{CS}$/P2B/CCP10	64			
RE2		I/O	ST	Digital I/O.
$\overline{CS}$		I	TTL	Parallel Slave Port chip select.
P2B		O	—	ECCP2 PWM Output B.
CCP10(3)		I/O	S/T	Capture 10 input/Compare 10 output/PWM10 output.
RE3/P3C/CCP9/REFO	63			
RE3		I/O	ST	Digital I/O.
P3C		O	—	ECCP3 PWM Output C.
CCP9(3,4)		I/O	S/T	Capture 9 input/Compare 9 output/PWM9 output.
REFO		O	—	Reference clock out.
RE4/P3B/CCP8	62			
RE4		I/O	ST	Digital I/O.
P3B		O	—	ECCP3 PWM Output B.
CCP8(4)		I/O	S/T	Capture 8 input/Compare 8 output/PWM8 output.
RE5/P1C/CCP7	61			
RE5		I/O	ST	Digital I/O.
P1C		O	—	ECCP1 PWM Output C.
CCP7(4)		I/O	S/T	Capture 7 input/Compare 7 output/PWM7 output.
RE6/P1B/CCP6	60			
RE6		I/O	ST	Digital I/O.
P1B		O	—	ECCP1 PWM Output B.
CCP6(4		I/O	S/T	Capture 6 input/Compare 6 output/PWM6 output.
RE7/ECCP2/P2A	59			
RE7		I/O	ST	Digital I/O.
ECCP2(2)		I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
P2A		O	—	ECCP2 PWM Output A.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD}); I^2C = I^2C™/SMBus

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K22 and PIC18F85K22 devices.

4: The CC6, CCP7, CCP8 and CCP9 pin placement depends on the setting of the ECCPMX Configuration bit (CONFIG3H<1>).

REGISTER 3-1: OSCCON: OSCILLATOR CONTROL REGISTER(1) (CONTINUED)

bit 2 **HFIOFS:** INTOSC Frequency Stable bit
1 = HF-INTOSC oscillator frequency is stable
0 = HF-INTOSC oscillator frequency is not stable

bit 1-0 **SCS<1:0>:** System Clock Select bits(4)
1x = Internal oscillator block (LF-INTOSC, MF-INTOSC or HF-INTOSC)
01 = SOSC oscillator
00 = Default primary oscillator (OSC1/OSC2 or HF-INTOSC with or without PLL; defined by the FOSC<3:0> Configuration bits, CONFIG1H<3:0>.)

Note 1: The Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).
2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.
3: Source selected by the INTSRC bit (OSCTUNE<7>).
4: Modifying these bits will cause an immediate clock source switch.
5: INTSRC = OSCTUNE<7> and MFIOSEL = OSCCON2<0>.
6: Lowest power option for an internal source.

REGISTER 3-2: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-0	U-0	U-0	R/W-0	U-0	R-x	R/W-0
—	SOSCRUN	—	—	SOSCGO	—	MFIOFS	MFIOSEL
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’

bit 6 **SOSCRUN:** SOSC Run Status bit
1 = System clock comes from a secondary SOSC
0 = System clock comes from an oscillator other than SOSC

bit 5-4 **Unimplemented:** Read as ‘0’

bit 3 **SOSCGO:** Oscillator Start Control bit
1 = Oscillator is running, even if no other sources are requesting it
0 = Oscillator is shut off if no other sources are requesting it (When the SOSC is selected to run from a digital clock input, rather than an external crystal, this bit has no effect.)

bit 2 **Unimplemented:** Read as ‘0’

bit 1 **MFIOFS:** MF-INTOSC Frequency Stable bit
1 = MF-INTOSC is stable
0 = MF-INTOSC is not stable

bit 0 **MFIOSEL:** MF-INTOSC Select bit
1 = MF-INTOSC is used in place of HF-INTOSC frequencies of 500 kHz, 250 kHz and 31.25 kHz
0 = MF-INTOSC is not used

REGISTER 5-1: RCON: RESET CONTROL REGISTER

R/W-0	R/W-1	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	SBOREN	$\overline{CM}$	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **IPEN:** Interrupt Priority Enable bit
1 = Enable priority levels on interrupts
0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)

bit 6 **SBOREN:** BOR Software Enable bit
If BOREN<1:0> = 01:
1 = BOR is enabled
0 = BOR is disabled
If BOREN<1:0> = 00, 10 or 11:
Bit is disabled and read as '0'.

bit 5 **$\overline{CM}$:** Configuration Mismatch Flag bit
1 = A Configuration Mismatch Reset has not occurred
0 = A Configuration Mismatch Reset has occurred (must be set in software after a Configuration Mismatch Reset occurs)

bit 4 **$\overline{RI}$:** RESET Instruction Flag bit
1 = The RESET instruction was not executed (set by firmware only)
0 = The RESET instruction was executed causing a device Reset (must be set in software after a Brown-out Reset occurs)

bit 3 **$\overline{TO}$:** Watchdog Time-out Flag bit
1 = Set by power-up, CLRWDT instruction or SLEEP instruction
0 = A WDT time-out occurred

bit 2 **$\overline{PD}$:** Power-Down Detection Flag bit
1 = Set by power-up or by the CLRWDT instruction
0 = Set by execution of the SLEEP instruction

bit 1 **$\overline{POR}$:** Power-on Reset Status bit
1 = A Power-on Reset has not occurred (set by firmware only)
0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)

bit 0 **$\overline{BOR}$:** Brown-out Reset Status bit
1 = A Brown-out Reset has not occurred (set by firmware only)
0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

Note 1: It is recommended that the $\overline{POR}$ bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.

2: Brown-out Reset is said to have occurred when $\overline{BOR}$ is '0' and $\overline{POR}$ is '1' (assuming that $\overline{POR}$ was set to '1' by software immediately after a Power-on Reset).

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	$\overline{\text{MCLR}}$ Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
ECCP1AS	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
ECCP1DEL	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
CCPR1H	PIC18F6XK22	PIC18F8XK22	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	PIC18F6XK22	PIC18F8XK22	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
PIR5	PIC18F65K22	PIC18F85K22	---0 -000	---0 -000	---u -uuu
PIR5	PIC18F66K22 PIC18F67K22	PIC18F86K22 PIC18F87K22	0000 0000	0000 0000	uuuu uuuu
PIE5	PIC18F65K22	PIC18F85K22	---0 0000	---0 0000	---u uuuu(1)
PIE5	PIC18F66K22 PIC18F67K22	PIC18F86K22 PIC18F87K22	0000 000	0000 0000	uuuu uuuu(1)
IPR4	PIC18F65K22	PIC18F85K22	--11 1111	--11 1111	--uu uuuu
IPR4	PIC18F66K22 PIC18F67K22	PIC18F86K22 PIC18F87K22	1111 1111	1111 1111	uuuu uuuu
PIR4	PIC18F65K22	PIC18F85K22	--00 0000	--00 0000	--uu uuuu(1)
PIR4	PIC18F66K22 PIC18F67K22	PIC18F86K22 PIC18F87K22	0000 0000	0000 0000	uuuu uuuu(1)
PIE4	PIC18F65K22	PIC18F85K22	--00 0000	--00 0000	--uu uuuu
PIE4	PIC18F66K22 PIC18F67K22	PIC18F86K22 PIC18F87K22	0000 0000	0000 0000	uuuu uuuu
CVRCON	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
CMSTAT	PIC18F6XK22	PIC18F8XK22	xxx- ----	xxx- ----	uuu- ----
TMR3H	PIC18F6XK22	PIC18F8XK22	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	PIC18F6XK22	PIC18F8XK22	xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0x00	uuuu uuuu
T3GCON	PIC18F6XK22	PIC18F8XK22	0000 0x00	0000 0000	uuuu uuuu
SPBRG1	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
RCREG1	PIC18F6XK22	PIC18F8XK22	0000 0000	0000 0000	uuuu uuuu
TXREG1	PIC18F6XK22	PIC18F8XK22	xxxx xxxx	xxxx xxxx	uuuu uuuu
TXSTA1	PIC18F6XK22	PIC18F8XK22	0000 0010	0000 0010	uuuu uuuu
RCSTA1	PIC18F6XK22	PIC18F8XK22	0000 000x	0000 000x	uuuu uuuu
T1GCON	PIC18F6XK22	PIC18F8XK22	0000 0x00	0000 0x00	uuuu -uuu
IPR6	PIC18F6XK22	PIC18F8XK22	---1 -111	---1 -111	---u -uuu
HLVDCON	PIC18F6XK22	PIC18F8XK22	0000 0101	0000 0101	uuuu uuuu
PSPCON	PIC18F6XK22	PIC18F8XK22	0000 ----	0000 ----	uuuu ----
PIR6	PIC18F6XK22	PIC18F8XK22	---0 -000	---0 -000	---u -uuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition.
Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt, and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

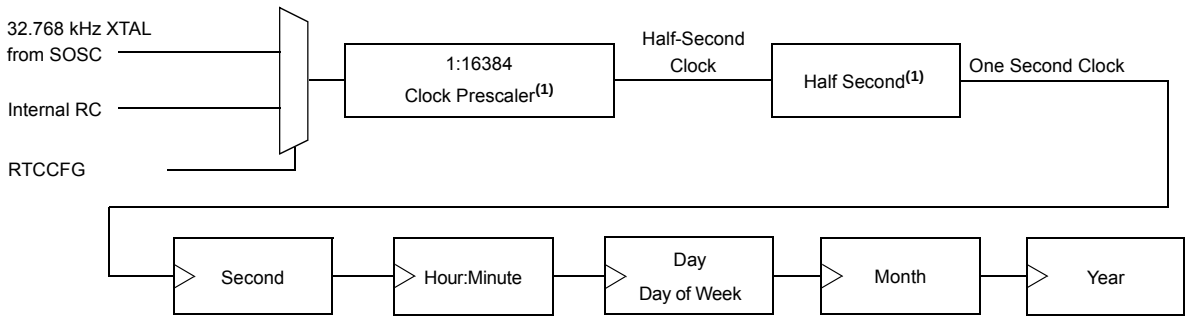
4: See Table 5-1 for Reset value for specific condition.

18.2.2 CLOCK SOURCE

As previously mentioned, the RTCC module is intended to be clocked by an external Real-Time Clock (RTC) crystal, oscillating at 32.768 kHz, but an internal oscillator can be used. The RTCC clock selection is decided by the RTCOSC bit (CONFIG3L<0>).

Calibration of the crystal can be done through this module to yield an error of 3 seconds or less per month. (For further details, see **Section 18.2.9 "Calibration"**.)

FIGURE 18-4: CLOCK SOURCE MULTIPLEXING



Note 1: Writing to the lower half of the MINSEC register resets all counters, allowing fraction of a second synchronization; clock prescaler is held in Reset when RTCEN = 0.

18.2.2.1 Real-Time Clock Enable

The RTCC module can be clocked by an external, 32.768 kHz crystal (SOSC oscillator) or the LF-INTOSC oscillator, which can be selected in CONFIG3L<0>.

If the external clock is used, the SOSC oscillator should be enabled. If LF-INTOSC is providing the clock, the INTOSC clock can be brought out to the RTCC pin by the RTSECSEL<1:0> bits (PADCFG<2:1>).

18.2.3 DIGIT CARRY RULES

This section explains which timer values are affected when there is a rollover:

- Time of Day: From 23:59:59 to 00:00:00 with a carry to the Day field
- Month: From 12/31 to 01/01 with a carry to the Year field
- Day of Week: From 6 to 0 with no carry (see Table 18-1)
- Year Carry: From 99 to 00; this also surpasses the use of the RTCC

For the day-to-month rollover schedule, see Table 18-2.

Because the following values are in BCD format, the carry to the upper BCD digit occurs at the count of 10, not 16 (SECONDS, MINUTES, HOURS, WEEKDAY, DAYS and MONTHS).

TABLE 18-1: DAY OF WEEK SCHEDULE

Day of Week	
Sunday	0
Monday	1
Tuesday	2
Wednesday	3
Thursday	4
Friday	5
Saturday	6

TABLE 18-2: DAY TO MONTH ROLLOVER SCHEDULE

Month	Maximum Day Field
01 (January)	31
02 (February)	28 or 29(1)
03 (March)	31
04 (April)	30
05 (May)	31
06 (June)	30
07 (July)	31
08 (August)	31
09 (September)	30
10 (October)	31
11 (November)	30
12 (December)	31

Note 1: See **Section 18.2.4 "Leap Year"**.

20.0 ENHANCED CAPTURE/COMPARE/PWM (ECCP) MODULE

PIC18F87K22 family devices have three Enhanced Capture/Compare/PWM (ECCP) modules: ECCP1, ECCP2 and ECCP3. These modules contain a 16-bit register, which can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register. These ECCP modules are upward compatible with CCP.

Note:	Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the ECCP1, ECCP2 or ECCP3 module. For example, the control register is named CCPxCON and refers to CCP1CON, CCP2CON and CCP3CON.

ECCP1, ECCP2 and ECCP3 are implemented as standard CCP modules with Enhanced PWM capabilities. These include:

- Provision for two or four output channels
- Output Steering modes
- Programmable polarity
- Programmable dead-band control
- Automatic shutdown and restart

The enhanced features are discussed in detail in **Section 20.4 "PWM (Enhanced Mode)"**.

The ECCP1, ECCP2 and ECCP3 modules use the control registers: CCP1CON, CCP2CON and CCP3CON. The control registers, CCP4CON through CCP10CON, are for the modules, CCP4 through CCP10.

REGISTER 20-5: PSTRxCON: PULSE STEERING CONTROL(1)

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
CMPL1	CMPL0	—	STRSYNC	STRD	STRC	STRB	STRA
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **CMPL<1:0>:** Complementary Mode Output Assignment Steering Sync bits
00 = See STR<D:A>
01 = PA and PB are selected as the complementary output pair
10 = PA and PC are selected as the complementary output pair
11 = PA and PD are selected as the complementary output pair

bit 5 **Unimplemented:** Read as '0'

bit 4 **STRSYNC:** Steering Sync bit
1 = Output steering update occurs on the next PWM period
0 = Output steering update occurs at the beginning of the instruction cycle boundary

bit 3 **STRD:** Steering Enable bit D
1 = PxD pin has the PWM waveform with polarity control from CCPxM<1:0>
0 = PxD pin is assigned to the port pin

bit 2 **STRC:** Steering Enable bit C
1 = PxC pin has the PWM waveform with polarity control from CCPxM<1:0>
0 = PxC pin is assigned to the port pin

bit 1 **STRB:** Steering Enable bit B
1 = PxB pin has the PWM waveform with polarity control from CCPxM<1:0>
0 = PxB pin is assigned to the port pin

bit 0 **STRA:** Steering Enable bit A
1 = PxA pin has the PWM waveform with polarity control from CCPxM<1:0>
0 = PxA pin is assigned to the port pin

Note 1: The PWM Steering mode is available only when the CCPxCON register bits, CCPxM<3:2> = 11 and PxM<1:0> = 00.

REGISTER 21-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I^2C™ MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN(1)	CKP	SSPM3(2)	SSPM2(2)	SSPM1(2)	SSPM0(2)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **WCOL:** Write Collision Detect bit

In Master Transmit mode:
1 = A write to the SSPxBUF register was attempted while the I^2C conditions were not valid for a transmission to be started (must be cleared in software)
0 = No collision

In Slave Transmit mode:
1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
0 = No collision

In Receive mode (Master or Slave modes):
This is a "don't care" bit.

bit 6 **SSPOV:** Receive Overflow Indicator bit

In Receive mode:
1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software)
0 = No overflow

In Transmit mode:
This is a "don't care" bit in Transmit mode.

bit 5 **SSPEN:** Master Synchronous Serial Port Enable bit(1)

1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins
0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** SCKx Release Control bit

In Slave mode:
1 = Releases clock
0 = Holds clock low (clock stretch), used to ensure data setup time

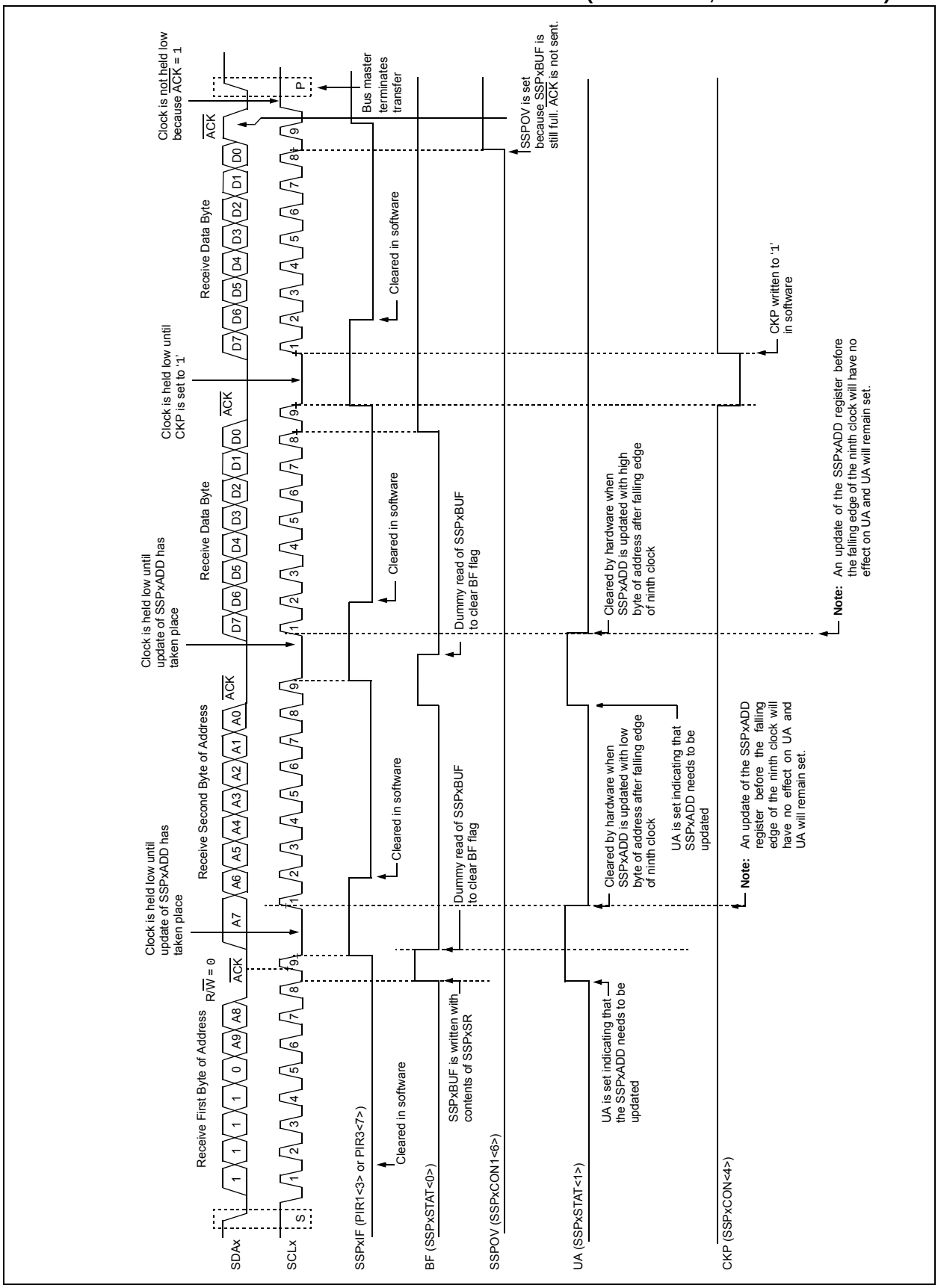
In Master mode:
Unused in this mode.

bit 3-0 **SSPM<3:0>:** Master Synchronous Serial Port Mode Select bits(2)

1111 = I^2C Slave mode: 10-bit address with Start and Stop bit interrupts enabled
1110 = I^2C Slave mode: 7-bit address with Start and Stop bit interrupts enabled
1011 = I^2C Firmware Controlled Master mode (slave Idle)
1001 = Load SSPMSK register at SSPxADD SFR address(3,4)
1000 = I^2C Master mode: clock = FOSC/(4 * (SSPxADD + 1))
0111 = I^2C Slave mode: 10-bit address
0110 = I^2C Slave mode: 7-bit address

Note 1: When enabled, the SDAx and SCLx pins must be configured as inputs.
2: Bit combinations not specifically listed here are either reserved or implemented in SPI mode only.
3: When SSPM<3:0> = 1001, any reads or writes to the SSPxADD SFR address actually accesses the SSPxMSK register.
4: This mode is only available when 7-Bit Address Masking mode is selected (MSSPMSK Configuration bit is '1').

FIGURE 21-16: I²C™ SLAVE MODE TIMING WITH SEN = 1 (RECEPTION, 10-BIT ADDRESS)



21.4.9 I²C™ MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPxCON2<1>) is programmed high and the I²C logic module is in the Idle state. When the RSEN bit is set, the SCLx pin is asserted low. When the SCLx pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPxADD<5:0> and begins counting. The SDAx pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, and if SDAx is sampled high, the SCLx pin will be deasserted (brought high). When SCLx is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. SDAx and SCLx must be sampled high for one TBRG. This action is then followed by assertion of the SDAx pin (SDAx = 0) for one TBRG while SCLx is high. Following this, the RSEN bit (SSPxCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDAx pin held low. As soon as a Start condition is detected on the SDAx and SCLx pins, the S bit (SSPxSTAT<3>) will be set. The SSPxIF bit will not be set until the Baud Rate Generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

2: A bus collision during the Repeated Start condition occurs if:

- SDAx is sampled low when SCLx goes from low-to-high.
- SCLx goes low before SDAx is asserted low. This may indicate that another master is attempting to transmit a data '1'.

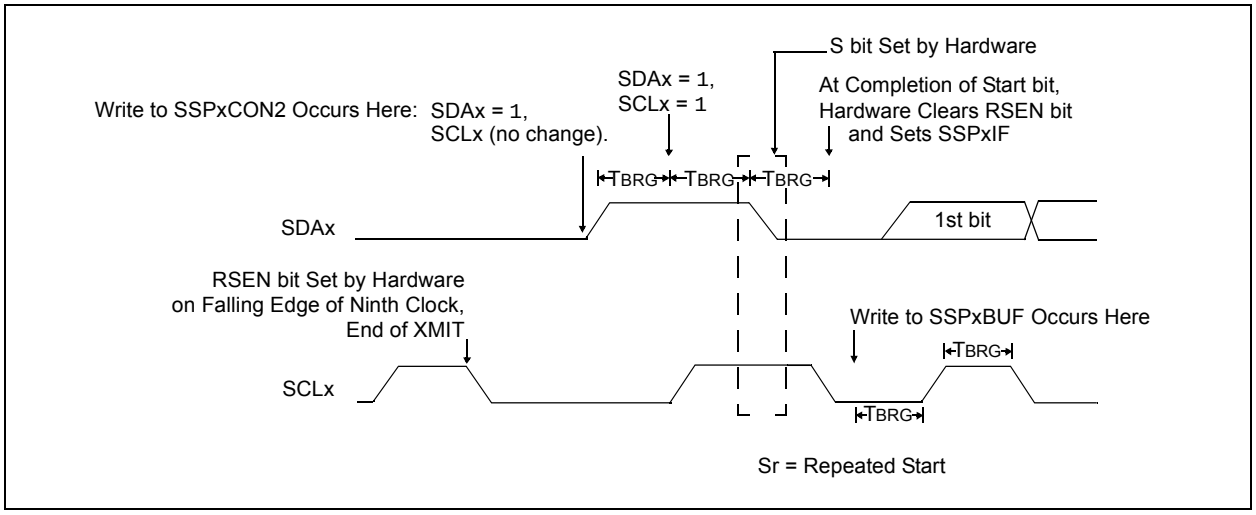
Immediately following the SSPxIF bit getting set, the user may write the SSPxBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

21.4.9.1 WCOL Status Flag

If the user writes the SSPxBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPxCON2 is disabled until the Repeated Start condition is complete.

FIGURE 21-22: REPEATED START CONDITION WAVEFORM



24.6 Comparator Interrupts

The comparator interrupt flag is set whenever any of the following occurs:

- Low-to-high transition of the comparator output
- High-to-low transition of the comparator output
- Any change in the comparator output

The comparator interrupt selection is done by the EVPOL<1:0> bits in the CMxCON register (CMxCON<4:3>).

In order to provide maximum flexibility, the output of the comparator may be inverted using the CPOL bit in the CMxCON register (CMxCON<5>). This is functionally identical to reversing the inverting and non-inverting inputs of the comparator for a particular mode.

An interrupt is generated on the low-to-high or high-to-low transition of the comparator output. This mode of interrupt generation is dependent on EVPOL<1:0> in the CMxCON register. When EVPOL<1:0> = 01 or 10, the interrupt is generated on a low-to-high or high-to-low transition of the comparator output. Once the interrupt is generated, it is required to clear the interrupt flag by software.

When EVPOL<1:0> = 11, the comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMSTAT<7:5>, to determine the actual change that occurred.

The CMPxIF bits (PIR6<2:0>) are the Comparator Interrupt Flags. The CMPxIF bits must be reset by clearing them. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated. Table 24-2 shows the interrupt generation with respect to comparator input voltages and EVPOL bit settings.

Both the CMPxIE bits (PIE6<2:0>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMPxIF bits will still be set if an interrupt condition occurs.

A simplified diagram of the interrupt section is shown in Figure 24-3.

Note:	The CMPxIF bits will not be set when EVPOL<1:0> = 00.

TABLE 24-2: COMPARATOR INTERRUPT GENERATION

CPOL	EVPOL<1:0>	Comparator Input Change	CxOUT Transition	Interrupt Generated
0	00	$V_{IN+} > V_{IN-}$	Low-to-High	No
		$V_{IN+} < V_{IN-}$	High-to-Low	No
	01	$V_{IN+} > V_{IN-}$	Low-to-High	Yes
		$V_{IN+} < V_{IN-}$	High-to-Low	No
	10	$V_{IN+} > V_{IN-}$	Low-to-High	No
		$V_{IN+} < V_{IN-}$	High-to-Low	Yes
	11	$V_{IN+} > V_{IN-}$	Low-to-High	Yes
		$V_{IN+} < V_{IN-}$	High-to-Low	Yes
1	00	$V_{IN+} > V_{IN-}$	High-to-Low	No
		$V_{IN+} < V_{IN-}$	Low-to-High	No
	01	$V_{IN+} > V_{IN-}$	High-to-Low	No
		$V_{IN+} < V_{IN-}$	Low-to-High	Yes
	10	$V_{IN+} > V_{IN-}$	High-to-Low	Yes
		$V_{IN+} < V_{IN-}$	Low-to-High	No
	11	$V_{IN+} > V_{IN-}$	High-to-Low	Yes
		$V_{IN+} < V_{IN-}$	Low-to-High	Yes

NOTES:

EXAMPLE 27-2: CURRENT CALIBRATION ROUTINE

```
#include "p18cxxx.h"

#define COUNT 500                       //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)
#define RCAL .027                       //R value is 4200000 (4.2M)
                                        //scaled so that result is in
                                        //1/100th of uA
#define ADSCALE 1023                    //for unsigned conversion 10 sig bits
#define ADREF 3.3                       //Vdd connected to A/D Vr+

int main(void)
{
    int i;
    int j = 0; //index for loop
    unsigned int Vread = 0;
    double VTot = 0;
    float Vavg=0, Vcal=0, CTMUISrc = 0;  //float values stored for calcs

//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();

CTMUCONHbits.CTMUEN = 1;                //Enable the CTMU
    for(j=0;j<10;j++)
    {
        CTMUCONHbits.IDISSEN = 1;       //drain charge on the circuit
        DELAY;                          //wait 125us
        CTMUCONHbits.IDISSEN = 0;       //end drain of circuit

        CTMUCONLbits.EDG1STAT = 1;      //Begin charging the circuit
                                        //using CTMU current source
        DELAY;                          //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;      //Stop charging circuit

        PIR1bits.ADIF = 0;              //make sure A/D Int not set
        ADCON0bits.GO=1;                //and begin A/D conv.
        while(!PIR1bits.ADIF);          //Wait for A/D convert complete

        Vread = ADRES;                  //Get the value from the A/D
        PIR1bits.ADIF = 0;              //Clear A/D Interrupt Flag
        VTot += Vread;                  //Add the reading to the total
    }

    Vavg = (float)(VTot/10.000);        //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
    CTMUISrc = Vcal/RCAL;               //CTMUISrc is in 1/100ths of uA

}
```

CPFSGT **Compare f with W, Skip if f > W**

Syntax: CPFSGT f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: (f) – (W),
skip if (f) > (W)
(unsigned comparison)

Status Affected: None

Encoding:

0110	010a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of the W by performing an unsigned subtraction.

If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE      CPFSGT REG, 0
NGREATER  :
GREATER   :
```
Before Instruction
PC = Address (HERE)
W = ?
After Instruction
If REG > W;
PC = Address (GREATER)
If REG ≤ W;
PC = Address (NGREATER)

CPFSLT **Compare f with W, Skip if f < W**

Syntax: CPFSLT f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: (f) – (W),
skip if (f) < (W)
(unsigned comparison)

Status Affected: None

Encoding:

0110	000a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.

If the contents of 'f' are less than the contents of W, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    CPFSLT REG, 1
NLESS   :
LESS    :
```
Before Instruction
PC = Address (HERE)
W = ?
After Instruction
If REG < W;
PC = Address (LESS)
If REG ≥ W;
PC = Address (NLESS)

30.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

30.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC® Flash MCUs and dsPIC® Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

30.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC® Flash microcontrollers and dsPIC® DSCs with the powerful, yet easy-to-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

30.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC® and dsPIC® Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming™.

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

31.5 AC (Timing) Characteristics

31.5.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS
2. TppS
3. TCC:ST (I^2C specifications only)
4. Ts (I^2C specifications only)

T			
F	Frequency	T	Time

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKO	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

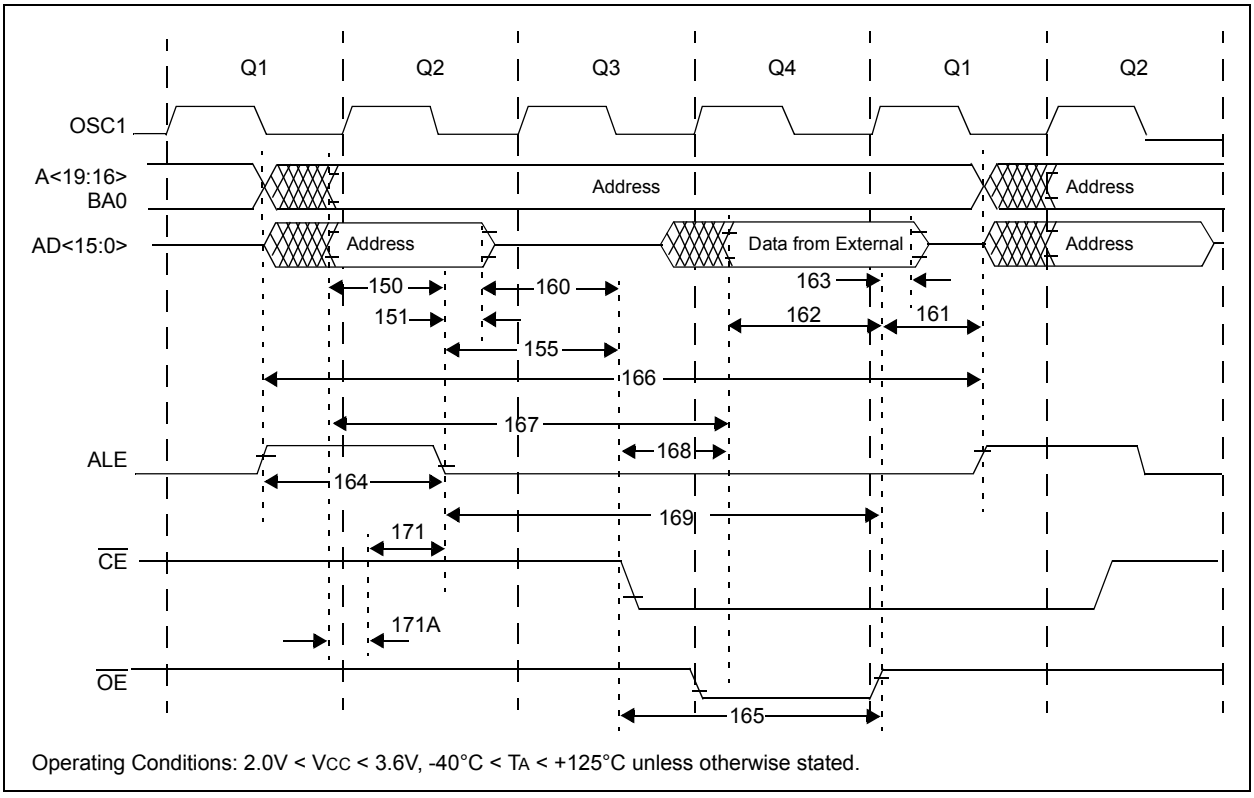
Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance
I^2C only			
AA	output access	High	High
BUF	Bus free	Low	Low

TCC:ST (I^2C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

FIGURE 31-7: PROGRAM MEMORY READ TIMING DIAGRAM

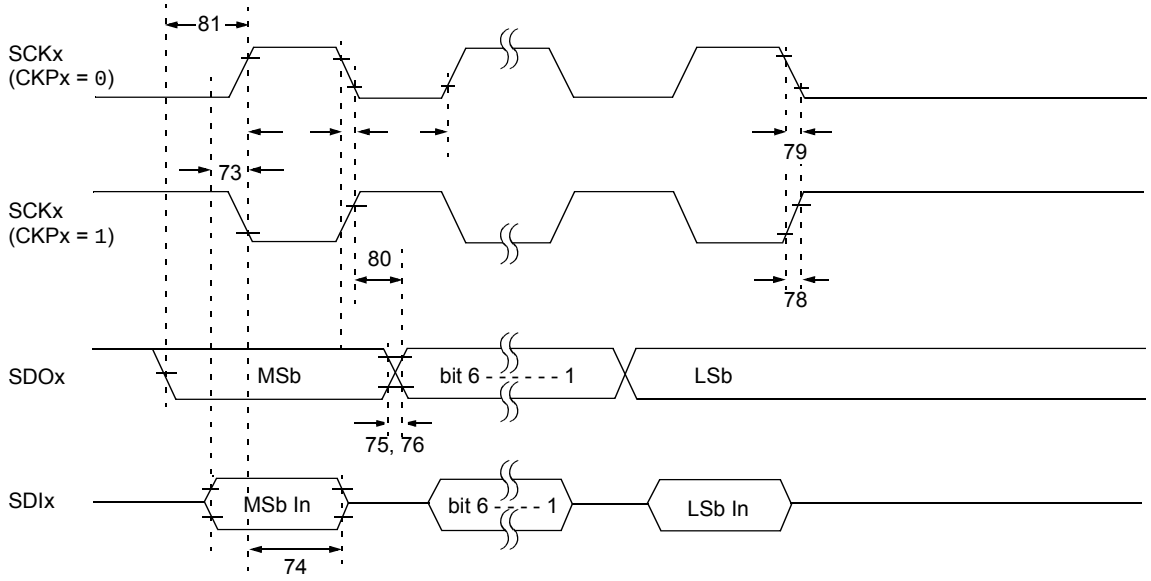


Operating Conditions: 2.0V < VCC < 3.6V, -40°C < TA < +125°C unless otherwise stated.

TABLE 31-11: CLKO AND I/O TIMING REQUIREMENTS

Param. No	Symbol	Characteristics	Min	Typ	Max	Units
150	TadV2alL	Address Out Valid to ALE ↓ (address setup time)	0.25 TCY – 10	—	—	ns
151	TalL2adl	ALE ↓ to Address Out Invalid (address hold time)	5	—	—	ns
155	TalL2oeL	ALE ↓ to $\overline{OE}$ ↓	10	0.125 TCY	—	ns
160	TadZ2oeL	AD High-Z to $\overline{OE}$ ↓ (bus release to $\overline{OE}$)	0	—	—	ns
161	ToeH2adD	$\overline{OE}$ ↑ to AD Driven	0.125 TCY – 5	—	—	ns
162	TadV2oeH	LS Data Valid before $\overline{OE}$ ↑ (data setup time)	20	—	—	ns
163	ToeH2adI	$\overline{OE}$ ↑ to Data In Invalid (data hold time)	0	—	—	ns
164	TalH2alL	ALE Pulse Width	—	0.25 TCY	—	ns
165	ToeL2oeH	$\overline{OE}$ Pulse Width	0.5 TCY – 5	0.5 TCY	—	ns
166	TalH2alH	ALE ↑ to ALE ↑ (cycle time)	—	TCY	—	ns
167	Tacc	Address Valid to Data Valid	0.75 TCY – 25	—	—	ns
168	Toe	$\overline{OE}$ ↓ to Data Valid		—	0.5 TCY – 25	ns
169	TalL2oeH	ALE ↓ to $\overline{OE}$ ↑	0.625 TCY – 10	—	0.625 TCY + 10	ns
171	TalH2csL	Chip Enable Active to ALE ↓	0.25 TCY – 20	—	—	ns
171A	TubL2oeH	AD Valid to Chip Enable Active	—	—	10	ns

FIGURE 31-15: EXAMPLE SPI MASTER MODE TIMING (CKE = 1)



Note: Refer to Figure 31-3 for load conditions.

TABLE 31-18: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)

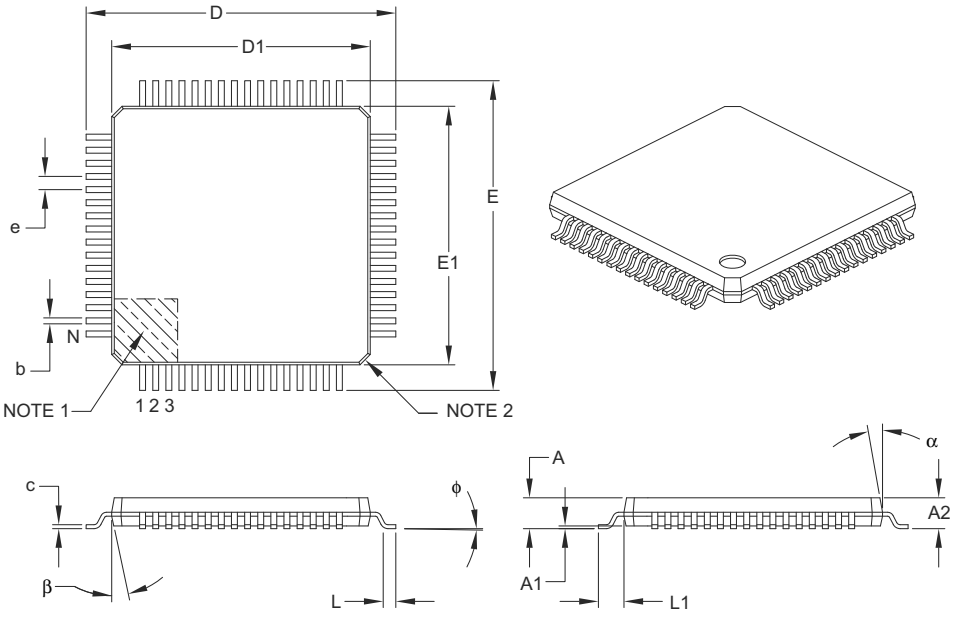
Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge	20	—	ns	
73A	TB2B	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2	1.5 TCY + 40	—	ns	
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge	40	—	ns	
75	TDOR	SDOx Data Output Rise Time	—	25	ns	
76	TDOF	SDOx Data Output Fall Time	—	25	ns	
78	TSCR	SCKx Output Rise Time (Master mode)	—	25	ns	
79	TSCF	SCKx Output Fall Time (Master mode)	—	25	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid after SCKx Edge	—	50	ns	
81	TDOV2SCH, TDOV2SCL	SDOx Data Output Setup to SCKx Edge	TCY	—	ns	

32.2 Package Details

The following sections give the technical details of the packages.

64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		64	
Lead Pitch	e		0.50 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	φ	0°	3.5°	7°
Overall Width	E		12.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B